

CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

5 July 2023

Issue Number 210220 Tender Type Reopening **Tender Date** 6 July 2023 14:30 pm to 15:30 pm Tender Time Renminbi 2 Billion Offering Amount Interest Type Fixed Coupon Rate 3.49% **Interest Payment Frequency** Annually **Interest Payment Date** 8 November 20 Years Original Tenor Maturity Date 8 November 2041 Issue and Settlement Date 10 July 2023 8 November 2021 Dated Date(Value Date) Listing Date 12 July 2023 **Clearing House** China Central Depository & Clearing Co.,Ltd China's Inter-bank Bond Market(CIBM) Market Rating Exempted for issuance in CIBM

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

*Disclaimer

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CDB's bond yield curve available at http://www.cdb.com.cn.